

Description

The BSS209PW uses advanced trench technology to provide excellent $R_{DS(ON)}$, This device is suitable for use as a load switch or in PWM applications.

General Features

V_{DS} = -20V,I_D = -1.8A

 $R_{DS(ON)} < 150 m\Omega @ V_{GS} = -4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

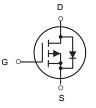
Product ID	Pack	Brand	Qty(PCS)
BSS209PW	SOT-323	HXY MOSFET	3000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Limit	Unit	
Vds	Drain-Source Voltage	-20	V	
Vgs	Gate-Source Voltage	±8	V	
ID	Drain Current-Continuous	-1.8	A	
Ы	Drain Current-Pulsed (Note 1)	-3	A	
PD	Maximum Power Dissipation	0.29	W	
Tj,Tstg	Operating Junction and Storage Temperature Range	-55 To 150	°C	
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	431	°C/W	







P-Channel MOSFET



Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
STATIC CHARACTERISTICE						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =-250µA	-20			V
Zero gate voltage drain current	IDSS	V _{DS} =-18V,V _{GS} = 0V			-1	μA
Gate-body leakage current	I _{GSS}	V_{GS} =±12V, V_{DS} = 0V			±100	nA
Gate threshold voltage (note2)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250µA	-0.4	-0.7	-1.0	V
	R _{DS(on)}	V _{GS} =-4.5V, I _D =-2A			150	mΩ
Drain-source on-resistance (note2)		V _{GS} =-2.5V, I _D =-1.0A			230	mΩ
Maximum Continuous Drain to Source Diode Forward Current	ls				-1.0	A
Diode forward voltage	V _{SD}	I _S =-1.0A, V _{GS} =0V			-1.2	V
Input capacitance	Ciss				680	pF
Output capacitance	Coss	V _{DS} =-8V,V _{GS} =0V, f =1MHz			130	pF
Reverse transfer capacitance	C _{rss}				95	pF
	te3)		·			
Turn-on delay time	t _{d(on)}				10	nS
Turn-on rise time	tr	V _{GS} =-4.5V,V _{DS} =-10V,			20	nS
Turn-off delay time	t _{d(off)}	I _D =-1.0A,R _G =5.1Ω			35	nS
Turn-off fall time	t _f				18	nS

Electrical Characteristics (T_A=25 $^\circ\!\!\!\mathrm{C}$ unless otherwise noted)

Notes:

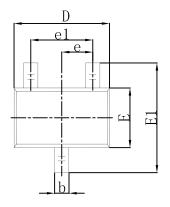
1. Surface mounted on FR4 board using the minimum recommended pad size.

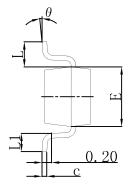
2. Pulse Test : Pulse Width=300µs, Duty Cycle=2%.

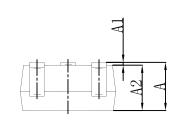
3. These parameters have no way to verify.



SOT-323 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
A	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.200	0.400	0.008	0.016	
С	0.080	0.150	0.003	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.450	0.085	0.096	
е	0.650) TYP	0.026 TYP		
e1	1.200	1.400	0.047	0.055	
L	0.525 REF		0.021 REF		
L1	0.260	0.460	0.010	0.018	
K	0°	8°	0°	8°	



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